February 2008



# 74LCX14 Low Voltage Hex Inverter with 5V Tolerant Schmitt Trigger Inputs

### Features

- 5V tolerant inputs
- 2.3V–3.6V V<sub>CC</sub> specifications provided
- 6.5ns t<sub>PD</sub> max. (V<sub>CC</sub> = 3.3V), 10µA I<sub>CC</sub> max.
- Power down high impedance inputs and outputs
- ±24mA output drive (V<sub>CC</sub> = 3.0V)
- Implements proprietary noise/EMI reduction circuitry
- Latch-up performance exceeds JEDEC 78 conditions
- ESD performance:
- Human body model > 2000V
- Machine model > 200V
- Leadless DQFN package

### General Description

The LCX14 contains six inverter gates each with a Schmitt trigger input. They are capable of transforming slowly changing input signals into sharply defined, jitter-free output signals. In addition, they have a greater noise margin than conventional inverters.

The LCX14 has hysteresis between the positive-going and negative-going input thresholds (typically 1.0V) which is determined internally by transistor ratios and is essentially insensitive to temperature and supply voltage variations.

The inputs tolerate voltages up to 7V allowing the interface of 5V, 3V and 2.5V systems.

The 74LCX14 is fabricated with advanced CMOS technology to achieve high speed operation while maintaining CMOS low power dissipation.

### **Ordering Information**

Order Number	Package Number	Package Description
74LCX14M	M14A	14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow
74LCX14SJ	M14D	14-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
74LCX14BQX <sup>(1)</sup>	MLP14A	14-Terminal Depopulated Quad Very-Thin Flat Pack No Leads (DQFN), JEDEC MO-241, 2.5 x 3.0mm
74LCX14MTC	MTC14	14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide

#### Note:

1. DQFN package available in Tape and Reel only.

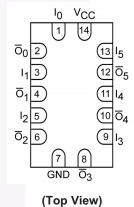
Device also available in Tape and Reel. Specify by appending suffix letter "X" to the ordering number.

All packages are lead free per JEDEC: J-STD-020B standard.

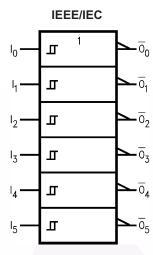
#### **Connection Diagrams** Pin Assignments for SOIC, SOP, and TSSOP 14 V<sub>CC</sub> I<sub>0</sub> 13 $\overline{0}_0$ I<sub>5</sub> 12 05 h 11 $\overline{0}_1$ ا₄ 10 $I_2$

 $\begin{array}{c} 1_{2} \\ \hline 0_{2} \\ \hline 0_{2} \\ \hline 0_{2} \\ \hline 0_{3} \\ \hline 0_{1} \\ \hline 0_{1} \\ \hline 0_{2} \\ \hline 0_{2} \\ \hline 0_{2} \\ \hline 0_{3} \hline 0_{3} \\ \hline 0_{3} \hline 0_{3} \\ \hline 0_{3} \hline 0_{3} \\ \hline 0_{3} \hline 0_{3} \hline 0_{3} \hline 0_{3} \hline \hline 0_{3} \hline 0$ 

### Pad Assignments for DQFN



## Logic Symbol



## **Truth Table**

Input	Output
A	ō
L	Н
Н	L

## **Pin Description**

Pin Names	Description
I <sub>n</sub>	Inputs
Ōn	Outputs

### **Absolute Maximum Ratings**

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Rating
V <sub>CC</sub>	Supply Voltage	-0.5V to +7.0V
VI	DC Input Voltage	-0.5V to +7.0V
Vo	DC Output Voltage, Output in HIGH or LOW State <sup>(2)</sup>	-0.5V to V <sub>CC</sub> + 0.5V
I <sub>IK</sub>	DC Input Diode Current, V <sub>I</sub> < GND	–50mA
I <sub>ОК</sub>	DC Output Diode Current	
	V <sub>O</sub> < GND	–50mA
	V <sub>O</sub> > V <sub>CC</sub>	+50mA
Ι <sub>Ο</sub>	DC Output Source/Sink Current	±50mA
I <sub>CC</sub>	DC Supply Current per Supply Pin	±100mA
I <sub>GND</sub>	DC Ground Current per Ground Pin	±100mA
T <sub>STG</sub>	Storage Temperature	–65°C to +150°C

#### Note:

2. I<sub>O</sub> Absolute Maximum Rating must be observed.

## Recommended Operating Conditions<sup>(3)</sup>

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to absolute maximum ratings.

Symbol	Parameter	Min.	Max.	Units
V <sub>CC</sub>	Supply Voltage			
	Operating	2.0	3.6	V
	Data Retention	1.5	3.6	
VI	Input Voltage	0	5.5	V
Vo	Output Voltage, HIGH or LOW State	0	V <sub>CC</sub>	V
I <sub>OH</sub> / I <sub>OL</sub>	Output Current			
	$V_{CC} = 3.0V - 3.6V$		±24	mA
	V <sub>CC</sub> = 2.7V–3.0V		±12	
	$V_{CC} = 2.3V - 2.7V$		±8	

Note:

3. Unused inputs must be held HIGH or LOW. They may not float.

### **DC Electrical Characteristics**

				T <sub>A</sub> =40°C	to +85°C	
Symbol	Parameter	V <sub>CC</sub> (V)	Conditions	Min.	Max.	Units
V <sub>t+</sub>	Positive Input Threshold	2.5		0.9	1.7	V
		3.0		1.2	2.2	
V <sub>t</sub> -	Negative Input Threshold	2.5		0.4	1.1	V
		3.0		0.6	1.5	
V <sub>H</sub>	Hysteresis	2.5		0.3	1.0	V
		3.0		0.4	1.2	
V <sub>OH</sub>	HIGH Level Output Voltage	2.3–3.6	$I_{OH} = -100 \mu A$	V <sub>CC</sub> - 0.2		V
		2.3	I <sub>OH</sub> = -8mA	1.8		
		2.7	$I_{OH} = -12mA$	2.2		
		3.0	$I_{OH} = -18mA$	2.4		
		3.0	$I_{OH} = -24mA$	2.2		
V <sub>OL</sub>	LOW Level Output Voltage	2.3–3.6	$I_{OL} = 100 \mu A$		0.2	V
		2.3	I <sub>OL</sub> = 8mA		0.6	
		2.7	$I_{OL} = 12mA$		0.4	
		3.0	I <sub>OL</sub> = 16mA		0.4	
		3.0	$I_{OL} = 24 \text{mA}$		0.55	
l <sub>l</sub>	Input Leakage Current	2.3–3.6	$0 \le V_I \le 5.5V$		±5.0	μA
I <sub>OFF</sub>	Power-Off Leakage Current	0	$V_{\rm I}$ or $V_{\rm O} = 5.5 V$		10	μA
I <sub>CC</sub>	Quiescent Supply Current	2.3–3.6	$V_{I} = V_{CC}$ or GND		10	μA
			$3.6V \le V_I \le 5.5V$		±10	
$\Delta I_{CC}$	Increase in I <sub>CC</sub> per Input	2.3–3.6	$V_{IH} = V_{CC} - 0.6V$		500	μA

## **AC Electrical Characteristics**

			$T_A = -40^{\circ}C$ to +85°C, $R_L = 500\Omega$					
			3V ± 0.3V, 50pF		₌ 2.7V, 50pF	V <sub>CC</sub> = 2.5 C <sub>L</sub> =	5V ± 0.2V, 30pF	
Symbol	Parameter	Min.	Max.	Min.	Max.	Min.	Max.	Units
t <sub>PHL</sub> , t <sub>PLH</sub>	Propagation Delay	1.5	6.5	1.5	7.5	1.5	7.8	ns
t <sub>OSHL</sub> , t <sub>OSLH</sub>	Output to Output Skew <sup>(4)</sup>		1.0					ns

Note:

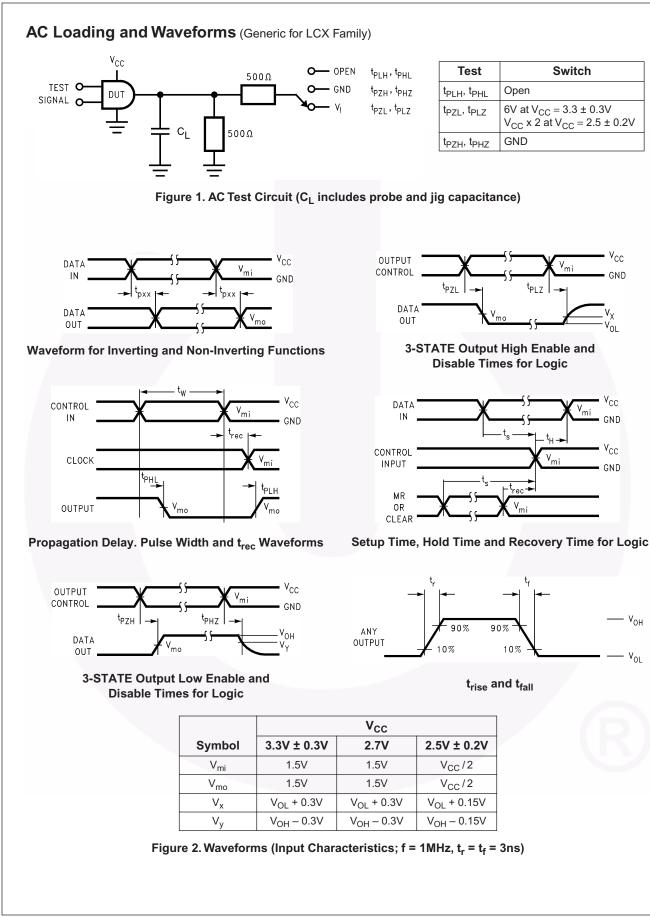
4. Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the same direction, either HIGH-to-LOW (t<sub>OSHL</sub>) or LOW-to-HIGH (t<sub>OSLH</sub>).

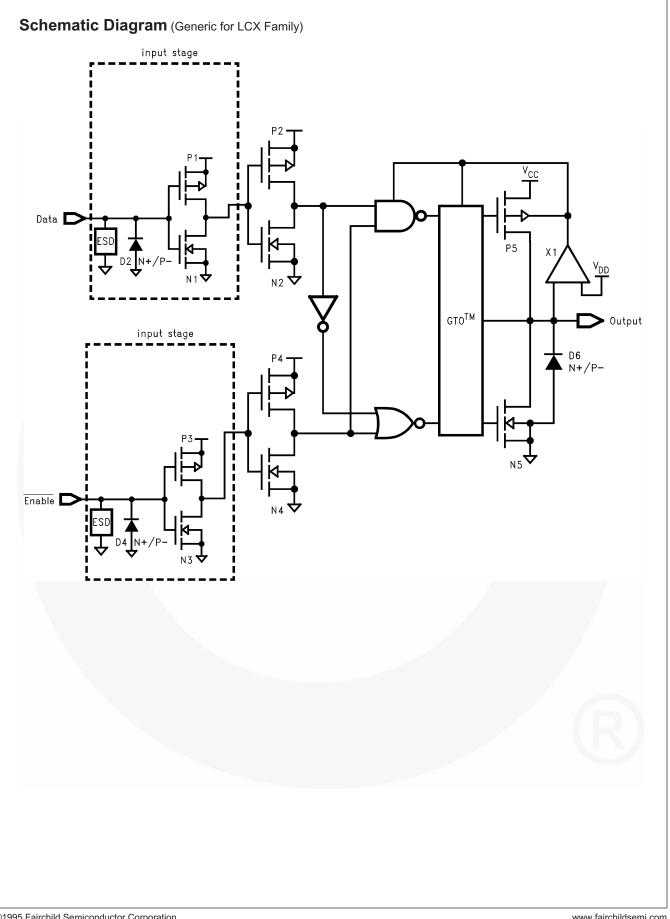
## **Dynamic Switching Characteristics**

				$T_A = 25^{\circ}C$	
Symbol	Parameter	V <sub>CC</sub> (V)	Conditions	Typical	Unit
V <sub>OLP</sub>	Quiet Output Dynamic Peak V <sub>OL</sub>	3.3	$C_L = 50 pF, V_{IH} = 3.3V, V_{IL} = 0V$	0.8	V
		2.5	$C_L = 30 pF$ , $V_{IH} = 2.5V$ , $V_{IL} = 0V$	0.6	
V <sub>OLV</sub>	Quiet Output Dynamic Valley $V_{OL}$	3.3	$C_L = 50 pF$ , $V_{IH} = 3.3V$ , $V_{IL} = 0V$	-0.8	V
		2.5	$C_{L} = 30 pF, V_{IH} = 2.5V, V_{IL} = 0V$	-0.6	

## Capacitance

Symbol	Parameter	Conditions	Typical	Units
C <sub>IN</sub>	Input Capacitance	$V_{CC} = Open, V_I = 0V \text{ or } V_{CC}$	7	pF
C <sub>OUT</sub>	Output Capacitance	$V_{CC} = 3.3 V$ , $V_I = 0 V$ or $V_{CC}$	8	pF
C <sub>PD</sub>	Power Dissipation Capacitance	$V_{CC} = 3.3V$ , $V_I = 0V$ or $V_{CC}$ , f = 10MHz	25	pF





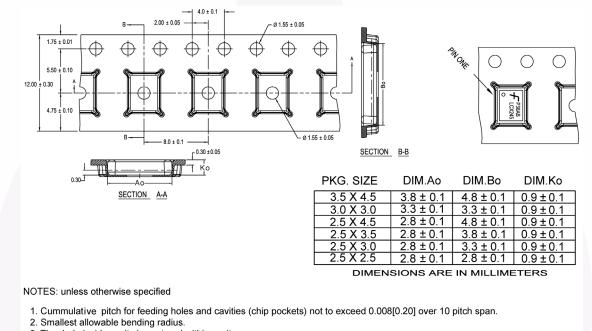
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### Tape and Reel Specification

#### **Tape Format for DQFN**

Package Designator	Tape Section	Number of Cavities	Cavity Status	Cover Tape Status
BQX	Leader (Start End)	125 (Тур.)	Empty	Sealed
	Carrier	3000	Filled	Sealed
	Trailer (Hub End)	75 (Тур.)	Empty	Sealed

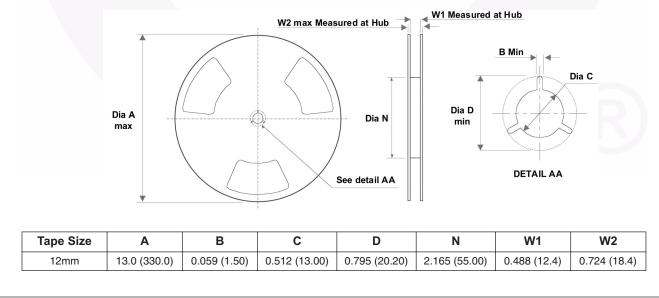
#### Tape Dimensions inches (millimeters)

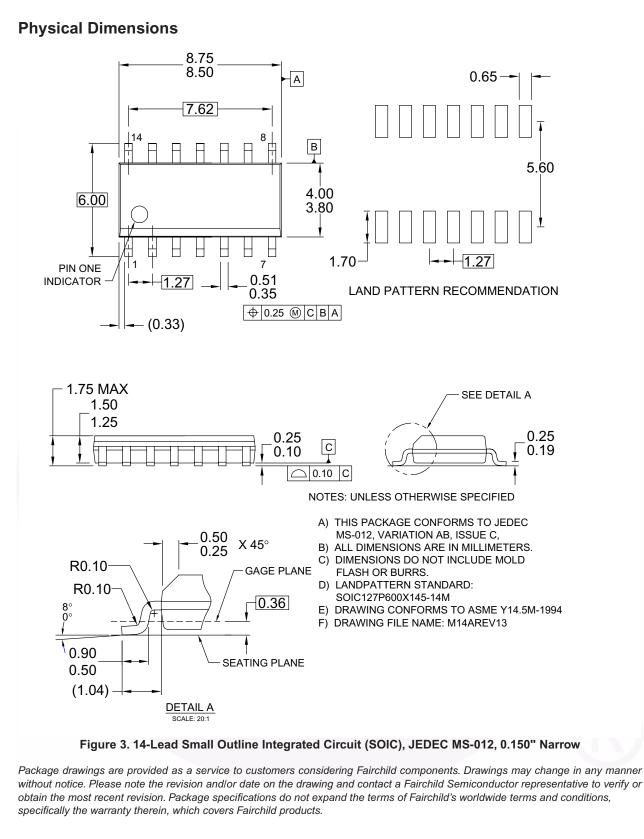


3. Thru hole inside cavity is centered within cavity.

- 4. Tolerance is  $\pm 0.002[0.05]$  for these dimensions on all 12mm tapes.
- 5. Ao and Bo measured on a plane 0.120[0.30] above the bottom of the pocket.
- 6. Ko measured from a plane on the inside bottom of the pocket to the top surface of the carrier.
- 7. Pocket position relative to sprocket hole measured as true position of pocket. Not pocket hole.
- 8. Controlling dimension is millimeter. Diemension in inches rounded.

Reel Dimensions inches (millimeters)

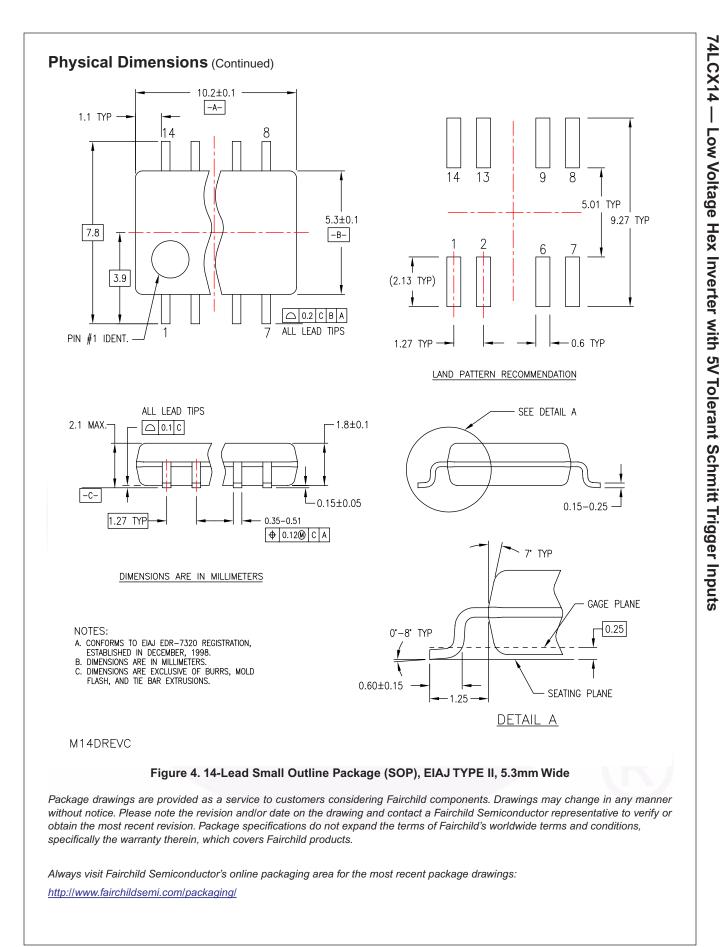




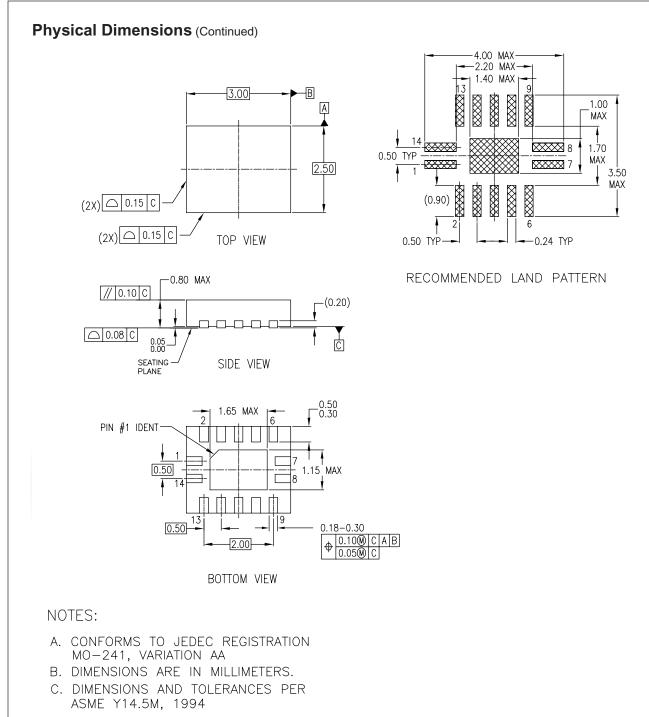
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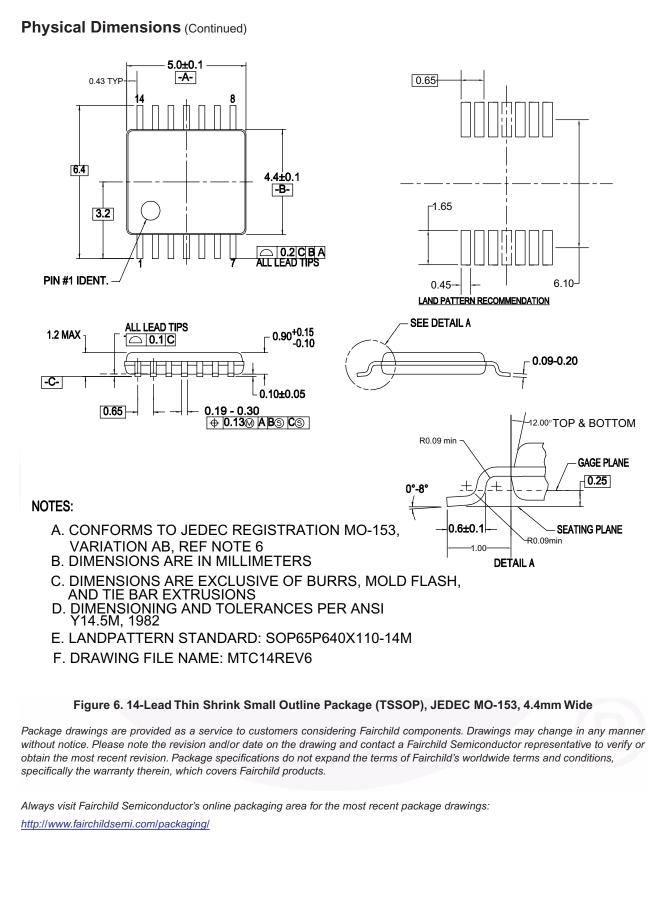
#### Figure 5. 14-Terminal Depopulated Quad Very-Thin Flat Pack No Leads (DQFN), JEDEC MO-241, 2.5 x 3.0mm

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